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**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

Applicant: Gurtej Singh Sandhu et al.  
Title: METHOD FOR FORMING A METALLIZATION LAYER

Docket No.: 303.085US4  
Filed: August 31, 2000  
Examiner: Renee Berry

Serial No.: 09/652,619  
Due Date: October 25, 2001  
Group Art Unit: 2818

Commissioner for Patents  
Washington, D.C. 20231

We are transmitting herewith the following attached items (as indicated with an "X"):

- A return postcard.  
 A Response to Restriction Requirement (1 Page).

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CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail, in an envelope addressed to: Commissioner for Patents, Washington, D.C. 20231, on this 25 day of October, 2001.

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